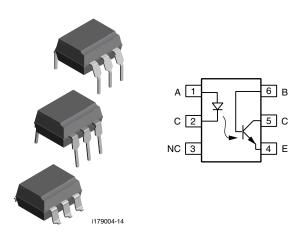


www.vishay.com

Vishay Semiconductors

Optocoupler, Phototransistor Output, with Base Connection



DESCRIPTION

The CNY17 is an optically coupled pair consisting of a gallium arsenide infrared emitting diode optically coupled to a silicon NPN phototransitor.

Signal information, including a DC level, can be transmitted by the device while maintaining a high degree of electrical isolation between input and output.

The CNY17 can be used to replace relays and transformers in many digital interface applications, as well as analog applications such as CRT modulation.

FEATURES

- Isolation test voltage: 5000 V_{RMS}
- · Long term stability
- · Industry standard dual-in-line package
- Material categorization:
 For definitions of compliance please see www.vishay.com/doc?99912





ROHS

AGENCY APPROVALS

- Underwriters lab file no. E52744
- cUL tested to CSA 22.2 bulletin 5A
- DIN EN 60747-5-5 (VDE 0884-5)
- BSI IEC 60950, IEC 60065
- FIMKO
- CQC

ORDERING INFORMATION						
C N Y 1 7 PART NUMBER	- # X	PACKAGE OPTION	# TAPE AND REEL Option	10.16 mm Option 9		
AGENCY CERTIFIED/PACKAGE		CTR	1 (%)			
UL, cUL, BSI, FIMKO	40 to 80	63 to 125	100 to 200	160 to 320		
DIP-6	CNY17-1	CNY17-2	CNY17-3	CNY17-4		
DIP-6, 400 mil, option 6	CNY17-1X006	CNY17-2X006	CNY17-3X006	CNY17-4X006		
SMD-6, option 7	CNY17-1X007T (1)	CNY17-2X007T (1)	CNY17-3X007T (1)	CNY17-4X007T (1)		
SMD-6, option 9	CNY17-1X009T (1)	CNY17-2X009T (1)	CNY17-3X009T (1)	CNY17-4X009T (1)		
VDE, UL, CUL, BSI, FIMKO	40 to 80	63 to 125	100 to 200	160 to 320		
DIP-6	CNY17-1X001	CNY17-2X001	CNY17-3X001	CNY17-4X001		
DIP-6, 400 mil, option 6	CNY17-1X016	CNY17-2X016	CNY17-3X016	CNY17-4X016		
SMD-64, option 7	CNY17-1X017	CNY17-2X017T (1)	CNY17-3X017T (1)	CNY17-4X017T (1)		

Note

SMD-6, option 9

(1) Also available in tubes, do not put T on the end.

CNY17-2X019T (1)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT			<u> </u>	
Reverse voltage		V_{R}	6	V
Forward current		I _F	60	mA
Forward surge current	t _p ≤ 10 μs	I _{FSM}	2.5	Α
LED power dissipation	at 25 °C	P _{diss}	70	mW
OUTPUT				
Collector emitter breakdown voltage		BV _{CEO}	70	V
Emitter base breakdown voltage		BV _{EBO}	7	V
Collector current		Ic	50	mA
Collector current	$t_p/T = 0.5, t_p \le 10 \text{ ms}$	I _C	100	mA
Power dissipation		P _{diss}	150	mW
COUPLER				
Isolation test voltage between emitter and detector	t = 1 s	V_{ISO}	5000	V_{RMS}
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Isolation thickness between emitter and detector			≥ 0.4	mm
Comparative tracking index per DIN IEC 112/VDE 0303, part 1			≥ 175	
Isolation resistance	V _{IO} = 500 V, T _{amb} = 25 °C	R _{IO}	≥ 10 ¹²	Ω
isolation resistance	$V_{IO} = 500 \text{ V}, T_{amb} = 100 ^{\circ}\text{C}$	R _{IO}	≥ 10 ¹¹	Ω
Storage temperature		T _{stg}	- 55 to + 150	°C
Operating temperature		T _{amb}	- 55 to + 110	°C
Soldering temperature (1)	2 mm from case, ≤ 10 s	T _{sld}	260	°C
Total power dissipation		P _{diss}	220	mW

Notes

⁽¹⁾ Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT	1201 CONDITION	IAIII	OTIVIDOL	1011111		WiFUX	0.11.1
Forward voltage	I _E = 60 mA		V _F		1.39	1.65	V
Breakdown voltage	I _B = 10 μA		V _{BR}	6	1.00	1.00	V
Reverse current	$V_R = 6 \text{ V}$		I _R	-	0.01	10	μA
Capacitance	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$		C _O		25		pF
Thermal resistance	11 - 7		R _{th}		750		K/W
OUTPUT							
Collector emitter capacitance	V _{CE} = 5 V, f = 1 MHz		C _{CE}		5.2		pF
Collector base capacitance	V _{CE} = 5 V, f = 1 MHz		C _{CB}		6.5		pF
Emitter base capacitance	V _{CE} = 5 V, f = 1 MHz		C _{EB}		7.5		pF
Thermal resistance			R _{th}		500		K/W
COUPLER						•	
Collector emitter, saturation voltage	$V_F = 10 \text{ mA}, I_C = 2.5 \text{ mA}$		V _{CEsat}		0.25	0.4	V
Coupling capacitance			C _C		0.6		pF
Collector emitter, leakage current	V _{CE} = 10 V	CNY17-1	I _{CEO}		2	50	nA
		CNY17-2	I _{CEO}		2	50	nA
		CNY17-3	I _{CEO}		5	100	nA
		CNY17-4	I _{CEO}		5	100	nA

Note

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
maximum ratings for extended periods of the time can adversely affect reliability.

Minimum and maximum values were tested requierements. Typical values are characteristics of the device and are the result of engineering
evaluations. Typical values are for information only and are not part of the testing requirements.



CURRENT TRANSFER RATIO (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
I _C /I _F	V _{CE} = 5 V, I _F = 10 mA	CNY17-1	CTR	40		80	%
		CNY17-2	CTR	63		125	%
		CNY17-3	CTR	100		200	%
		CNY17-4	CTR	160		320	%
	V _{CE} = 5 V, I _F = 1 mA	CNY17-1	CTR	13	30		%
		CNY17-2	CTR	22	45		%
		CNY17-3	CTR	34	70		%
		CNY17-4	CTR	56	90		%

SWITCHING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
LINEAR OPERATION (without saturation)							
Turn-on time	$I_F = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 75 \Omega$		t _{on}		3		μs
Rise time	$I_F = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 75 \Omega$		t _r		2		μs
Turn-off time	$I_F = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 75 \Omega$		t _{off}		2.3		μs
Fall time	$I_F = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 75 \Omega$		t _f		2		μs
Cut-off frequency	$I_F = 10 \text{ mA}, V_{CC} = 5 \text{ V}, R_L = 75 \Omega$		f _{CO}		110		kHz
SWITCHING OPERAT	TION (with saturation)						
	I _F = 20 mA	CNY17-1	t _{on}		3		μs
Turn-on time	I _F = 10 mA	CNY17-2	t _{on}		4.2		μs
rum-on time		CNY17-3	t _{on}		4.2		μs
	$I_F = 5 \text{ mA}$	CNY17-4	t _{on}		6		μs
Rise time	I _F = 20 mA	CNY17-1	t _r		2		μs
	I _F = 10 mA	CNY17-2	t _r		3		μs
		CNY17-3	t _r		3		μs
	$I_F = 5 \text{ mA}$	CNY17-4	t _r		4.6		μs
	$I_F = 20 \text{ mA}$	CNY17-1	t _{off}		18		μs
Turn-off time	$I_F = 10 \text{ mA}$	CNY17-2	t _{off}		23		μs
		CNY17-3	t _{off}		23		μs
	$I_F = 5 \text{ mA}$	CNY17-4	t _{off}		25		μs
Fall time	$I_F = 20 \text{ mA}$	CNY17-1	t _f		11		μs
	I _F = 10 mA	CNY17-2	t _f		14		μs
ı alı tillic		CNY17-3	t _f		14		μs
	$I_F = 5 \text{ mA}$	CNY17-4	t _f		15		μs

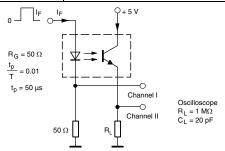


Fig. 1 - Test Circuit, Non-Saturated Operation

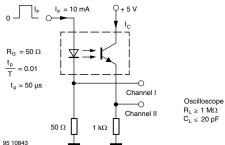


Fig. 2 - Test Circuit, Saturated Operation

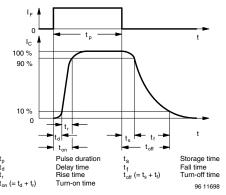


Fig. 3 - Switching Times

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

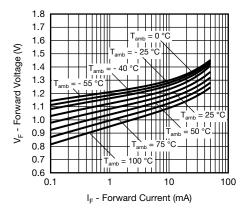


Fig. 4 - Forward Voltage vs. Forward Current

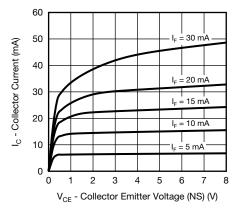


Fig. 5 - Collector Current vs. Collector Emitter Voltage (NS)

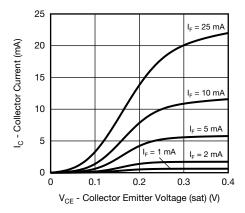


Fig. 6 - Collector Current vs. Collector Emitter Voltage (sat)

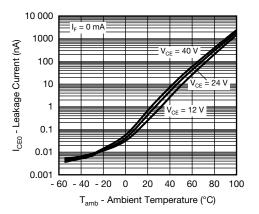


Fig. 7 - Leakage Current vs. Ambient Temperature

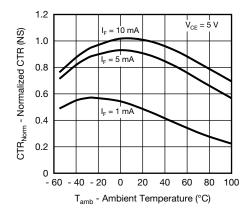


Fig. 8 - Normalized CTR (NS) vs. Ambient Temperature

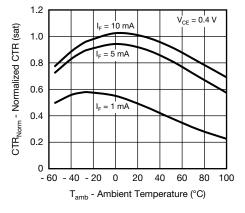
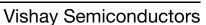


Fig. 9 - Normalized CTR (sat) vs. Ambient Temperature





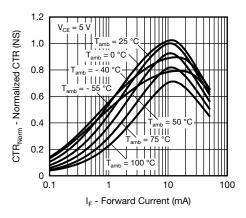


Fig. 10 - Normalized CTR (NS) vs. Forward Current

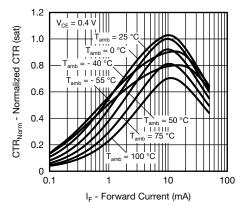


Fig. 11 - Normalized CTR (sat) vs. Forward Current

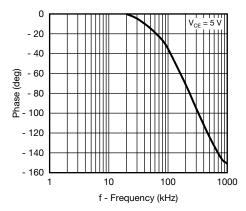


Fig. 12 - CTR Frequency vs. Phase Angle

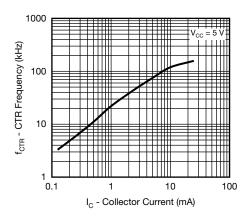


Fig. 13 - CTR Frequency vs. Collector Current

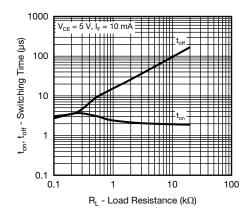
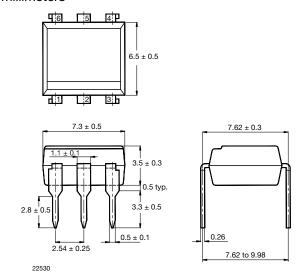
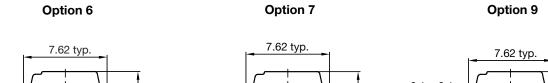
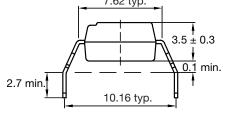


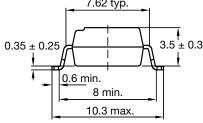
Fig. 14 - Switching Time vs. Load Resistance

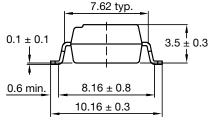
PACKAGE DIMENSIONS in millimeters

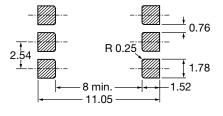


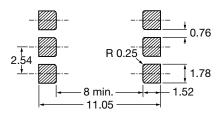












20802-34

PACKAGE MARKING



Notes

- VDE logo is only marked on option 1 parts. Option information is not marked on the part.
- Tape and reel suffix (T) is not part of the package marking.



TUBE AND TAPE INFORMATION

DEVICES PER TUBE						
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX			
DIP-6	50	40	2000			

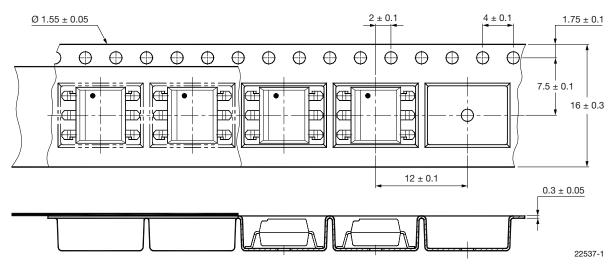


Fig. 15 - Tape and Reel Drawing, 1000 Units per Reel



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000